

## Features

- Halogen Free. "Green" Device (Note 1)
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## Maximum Ratings @ 25°C Unless Otherwise Specified

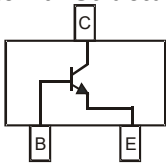
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Maximum Thermal Resistance: 625°C/W Junction to Ambient

Parameter	Symbol	Rating	Unit
Collector-Base Voltage	$V_{CBO}$		V
BC846A-BC846C		80	
BC847A-BC847C		50	
BC848A-BC848C, BC849B-BC849C		30	
Collector-Emitter Voltage	$V_{CEO}$		V
BC846A-BC846C		65	
BC847A-BC847C		45	
BC848A-BC848C, BC849B-BC849C		30	
Emitter-Base Voltage	$V_{EBO}$	6	V
Collector Current	$I_C$	100	mA
Collector Power Dissipation @ $T_A=25^\circ\text{C}$ (Note2)	$P_C$	225	mW

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. Transistor mounted on an FR4 printed-circuit board

## Internal Structure

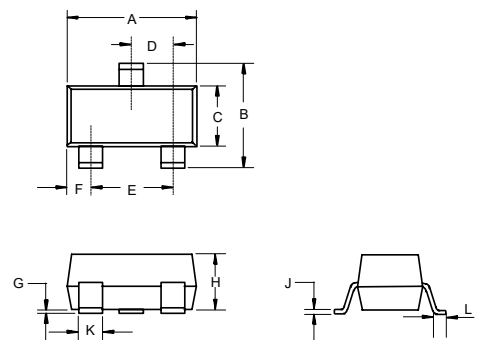


## Marking:

BC846A:1A; BC846B:1B; BC846C:1C;  
BC847A:1E; BC847B:1F; BC847C:1G;  
BC848A:1J; BC848B:1K; BC848C:1L;  
BC849B:49B; BC849C:49C;

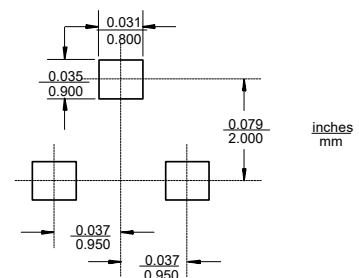
# NPN Plastic-Encapsulate Transistors

## SOT-23



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.083	0.104	2.10	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
H	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.014	0.020	0.35	0.51	
L	0.007	0.020	0.20	0.50	

## Suggested Solder Pad Layout



Electrical Characteristics @  $T_A=25^\circ\text{C}$  Unless Otherwise Specified

Parameter	Symbol	Min	Typ	Max	Units	Conditions
Collector-Base Breakdown Voltage BC846A-BC846C BC847A-BC847C BC848A-BC848C,BC849B-BC849C	$V_{(BR)CBO}$	80 50 30			V	$I_C=10\mu\text{A}, I_E=0$
Collector-Emitter Breakdown Voltage BC846A-BC846C BC847A-BC847C BC848A-BC848C,BC849B-BC849C	$V_{(BR)CEO}$	65 45 30			V	$I_C=10\text{mA}, I_B=0$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6			V	$I_E=10\mu\text{A}, I_C=0$
Collector Cut-off Current BC846A-BC846C BC847A-BC847C BC848A-BC848C,BC849B-BC849C	$I_{CBO}$			0.1	$\mu\text{A}$	$V_{CB}=70\text{V}, I_E=0$ $V_{CB}=50\text{V}, I_E=0$ $V_{CB}=30\text{V}, I_E=0$
Emitter Cutoff Current BC846A-BC846C BC847A-BC847C BC848A-BC848C,BC849B-BC849C	$I_{CEO}$			0.1	$\mu\text{A}$	$V_{CE}=60\text{V}, I_B=0$ $V_{CE}=45\text{V}, I_B=0$ $V_{CE}=30\text{V}, I_B=0$
Emitter Cutoff Current	$I_{EBO}$			0.1	$\mu\text{A}$	$V_{EB}=5\text{V}, I_C=0$
DC Current Gain BC846A/BC847A/BC848A BC846B/BC847B/BC848B/BC849B BC846C/BC847C/BC848C/BC849C	$h_{FE(1)}$		90 150 400			$V_{CE}=5\text{V}, I_C=10\mu\text{A}$
DC Current Gain BC846A/BC847A/BC848A BC846B/BC847B/BC848B/BC849B BC846C/BC847C/BC848C/BC849C	$h_{FE(2)}$	110 200 420		220 450 800		$V_{CE}=5\text{V}, I_C=2\text{mA}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$			0.25	V	$I_C=10\text{mA}, I_B=0.5\text{mA}$
				0.5	V	$I_C=100\text{mA}, I_B=5\text{mA}$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$		0.7		V	$I_C=10\text{mA}, I_B=0.5\text{mA}$
			0.9	1.1	V	$I_C=100\text{mA}, I_B=5\text{mA}$
Base-Emitter On Voltage	$V_{BE(on)}$	0.58	0.66	0.7	V	$V_{CE}=5\text{V}, I_C=2\text{mA}$
				0.77	V	$V_{CE}=5\text{V}, I_C=10\text{mA}$
Transition Frequency	$f_T$	100			MHz	$V_{CE}=5\text{V}, I_C=10\text{mA}, f=100\text{MHz}$
Collector Output Capacitance	$C_{ob}$			4.5	pF	$V_{CB}=10\text{V}, I_E=0, f=0.1\text{MHz}$

**Curve Characteristics**

Fig. 1 - Static Characteristics

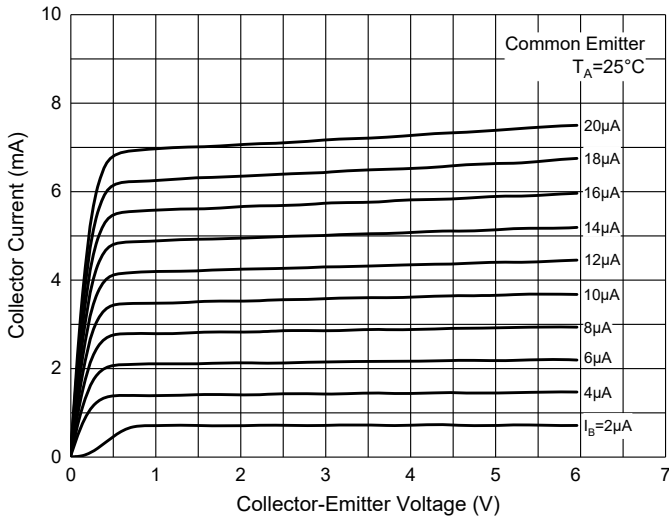


Fig. 2 - DC Current Gain Characteristics

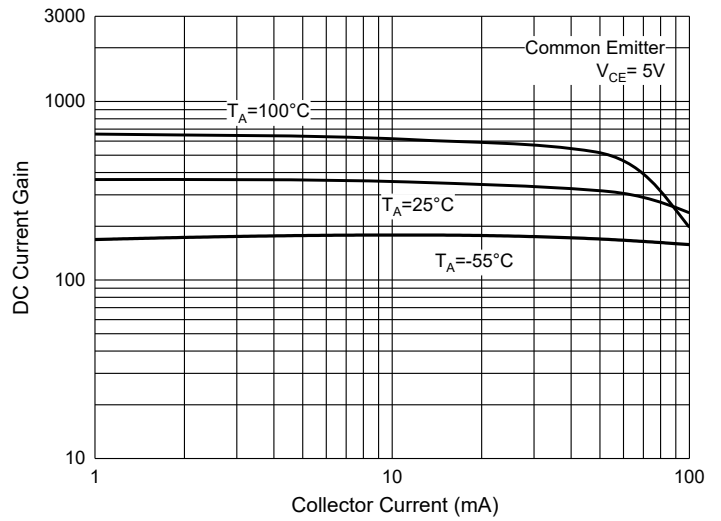


Fig. 3 - Base-Emitter Saturation Voltage Characteristics

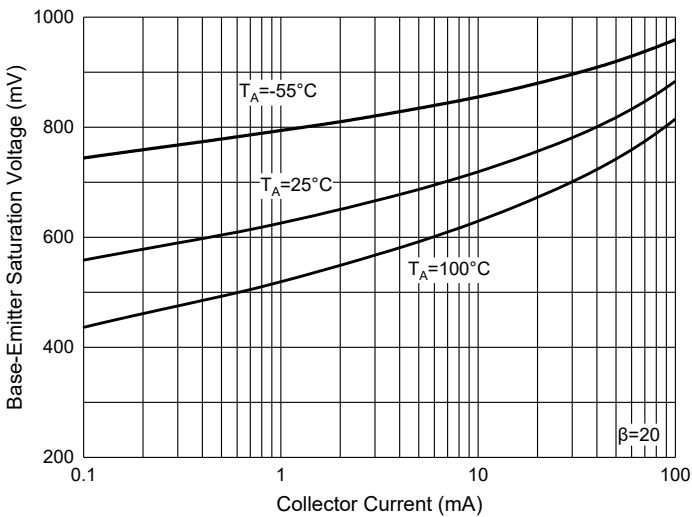


Fig. 4 - Collector-Emitter Saturation Voltage Characteristics

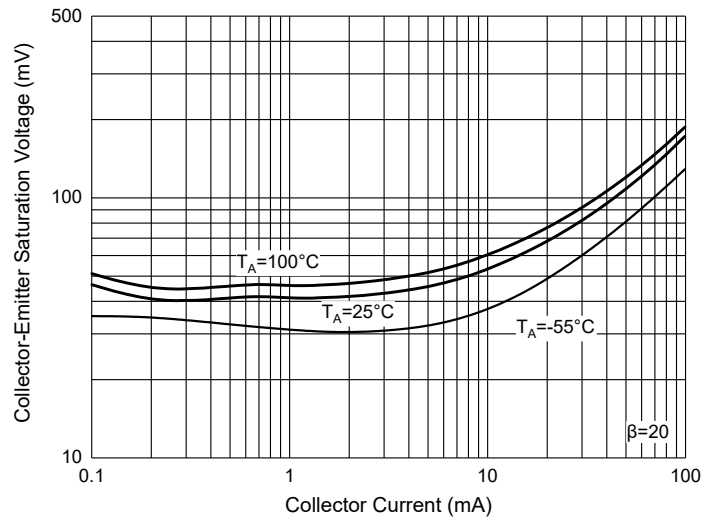


Fig. 5 - Base-Emitter Voltage Characteristics

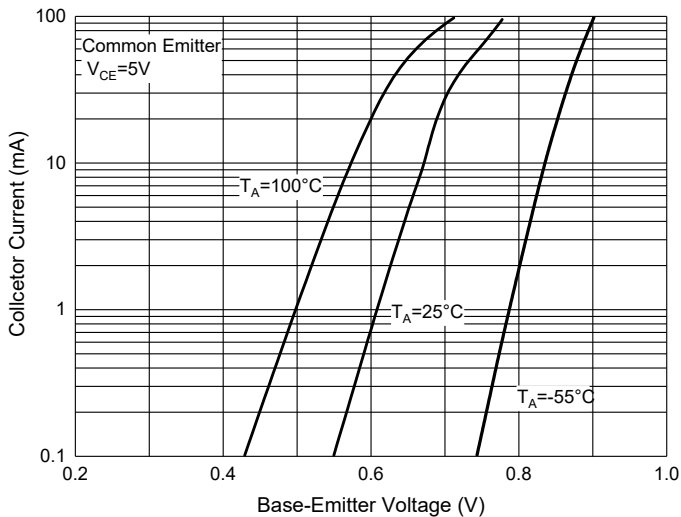
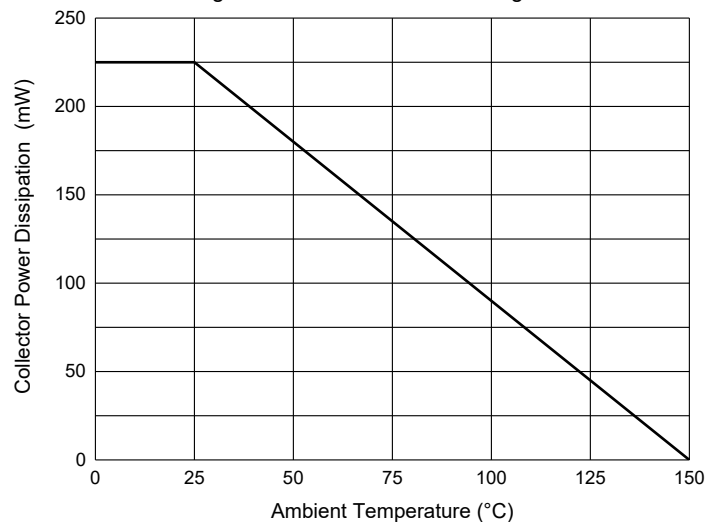


Fig. 6 - Collector Power Derating Curve



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

**\*\*\*IMPORTANT NOTICE\*\*\***

**Micro Commercial Components Corp.** reserves the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes. **Micro Commercial Components Corp.** does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold **Micro Commercial Components Corp.** and all the companies whose products are represented on our website, harmless against all damages. **Micro Commercial Components Corp.** products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

**\*\*\*LIFE SUPPORT\*\*\***

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

**\*\*\*CUSTOMER AWARENESS\*\*\***

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.